

K2161-VB Datasheet N-Channel 200 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------------------|------------------------|-------|--|--|
| V _{DS} (V) | 200 | | | |
| $R_{DS(on)}\left(\Omega\right)$ | V _{GS} = 10 V | 0.265 | | |
| Q _g (Max.) (nC) | 16 | | | |
| Q _{gs} (nC) | 5 | | | |
| Q _{gd} (nC) | 8 | | | |
| Configuration | Single | | | |

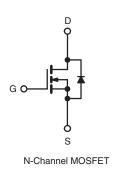
FEATURES

- · Isolated Package
- High Voltage Isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz



- Sink to Lead Creepage Distance = 4.8 mm
- 175 °C Operating Temperature
- · Dynamic dV/dt Rating
- Low Thermal Resistance
- Lead (Pb)-free Available





| ABSOLUTE MAXIMUM RATINGS T _C = 25 °C, unless otherwise noted | | | | | | |
|--|-------------------------|-------------------------|-----------------------------------|------------------|----------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V_{DS} | 200 | V | |
| Gate-Source Voltage | | | V_{GS} | ± 20 | | |
| Continuous Drain Current | V _{GS} at 10 V | T _C = 25 °C | | 10 | | |
| | V _{GS} at 10 V | T _C = 100 °C | I _D | 6.5 | A | |
| Pulsed Drain Current ^a | | | I _{DM} | 32 | | |
| Linear Derating Factor | | | | 0.24 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 36 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 7.2 | А | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 3.7 | mJ | |
| Maximum Power Dissipation | T _C = | 25 °C | P_{D} | 37 | W | |
| Peak Diode Recovery dV/dtc | | | dV/dt | 5.5 | V/ns | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 175 | °C | |
| Soldering Recommendations (Peak Temperature) | for 10 s | | | 300 ^d | | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf ⋅ in | |
| | | | | 1.1 | N · m | |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 1.0 mH, R_G = 25 Ω , I_{AS} = 7.2 A (see fig. 12). c. $I_{SD} \le 9.2$ A, $dI/dt \le 110$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.

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| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------------|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 65 | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 4.1 | C/VV | |

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|--|---|------------|-------------|-------|------|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} : | 200 | - | - | ٧ | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | - | 0.13 | - | V/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | $V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$ | | - | 4.0 | V |
| Gate-Source Leakage | I _{GSS} | V _{GS} = ± 20 V | | - | - | ± 100 | nA |
| Zana Oata Wallana Busin Oamani | | V _{DS} = | V _{DS} = 200 V, V _{GS} = 0 V | | - | 25 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =160 V | , V _{GS} = 0 V, T _J = 150 °C | - | - | 250 | μΑ |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 4.3 A ^b | - | 0.265 | - | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} = | = 50 V, I _D = 4.3 A ^b | 2.3 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, | | - | 560 | - | - pF |
| Output Capacitance | C _{oss} |] | $V_{DS} = 25 \text{ V},$ | | 260 | - | |
| Reverse Transfer Capacitance | C _{rss} | f = 1.0 MHz, see fig. 5 f = 1.0 MHz | | - | 110 | - | |
| Drain to Sink Capacitance | С | | | - | 12 | - | |
| Total Gate Charge | Qg | | I _D = 9.2 A, V _{DS} = 80 V, see fig. 6 and 13 ^b | - | - | 16 | nC |
| Gate-Source Charge | Q _{gs} | V _{GS} = 10 V | | - | - | 4.4 | |
| Gate-Drain Charge | Q_{gd} | 1 | | - | - | 7.7 | |
| Turn-On Delay Time | t _{d(on)} | | ' | | 8.8 | - | - ns |
| Rise Time | t _r | $V_{DD} = 100 \text{ V, } I_{D} = 9.2 \text{ A,}$ $R_{G} = 18 \Omega, R_{D} = 5.2 \Omega,$ see fig. 10^{b} | | - | 30 | - | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 19 | - | |
| Fall Time | t _f | | | - | 20 | - | |
| Internal Drain Inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | = | 4.5 | - | |
| Internal Source Inductance | L _S | | | - | 7.5 | - | - nH |
| Drain-Source Body Diode Characteristic | s | | | | • | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | 10 | - | A |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | 32 | - | |
| Body Diode Voltage | V_{SD} | $T_J = 25 ^{\circ}\text{C}, \ I_S = 7.2 \text{A}, \ V_{GS} = 0 \text{V}^{\text{b}}$ | | - | - | 2.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 9.2 A, dl/dt = 100 A/μs ^b | | - | 130 | 260 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 0.65 | 1.3 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic tu | n-on is dor | ninated by | L_S and I |) | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

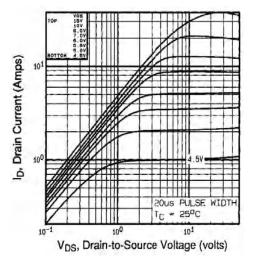


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

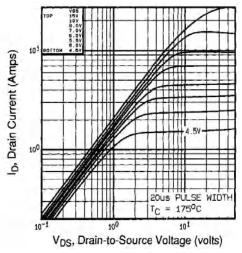


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

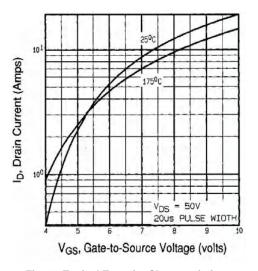


Fig. 3 - Typical Transfer Characteristics

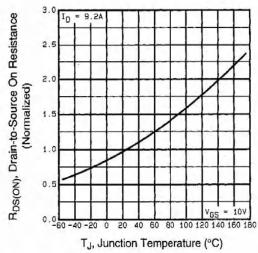


Fig. 4 - Normalized On-Resistance vs. Temperature

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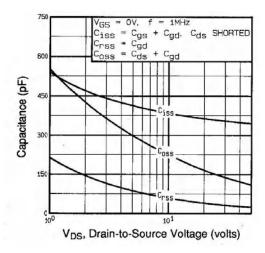


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

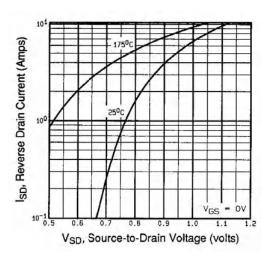


Fig. 7 - Typical Source-Drain Diode Forward Voltage

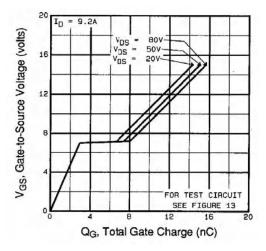


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

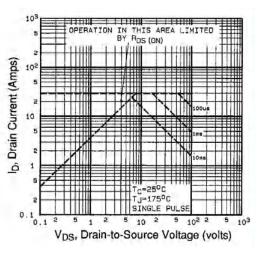


Fig. 5 - Fig. 8 - Maximum Safe Operating Area



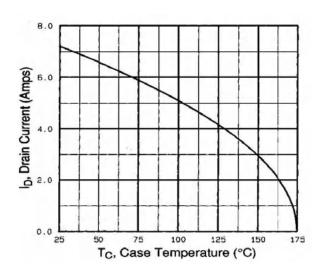


Fig. 9 - Maximum Drain Current vs. Case Temperature

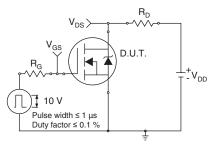


Fig. 10a - Switching Time Test Circuit

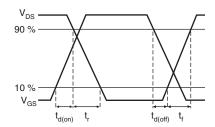


Fig. 10b - Switching Time Waveforms

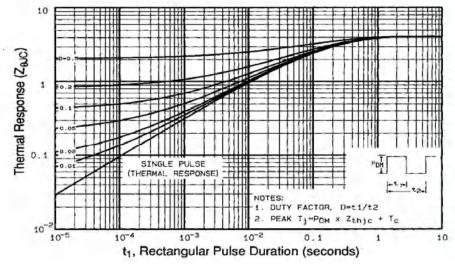


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

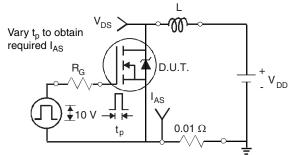


Fig. 12a - Unclamped Inductive Test Circuit

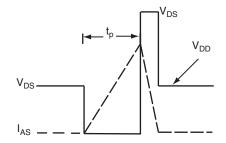
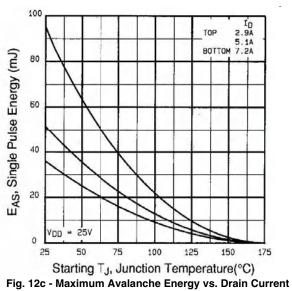


Fig. 12b - Unclamped Inductive Waveforms





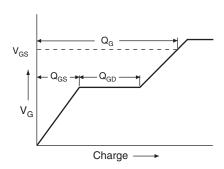


Fig. 13a - Basic Gate Charge Waveform

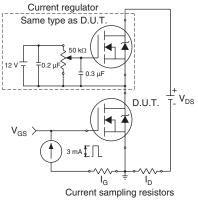
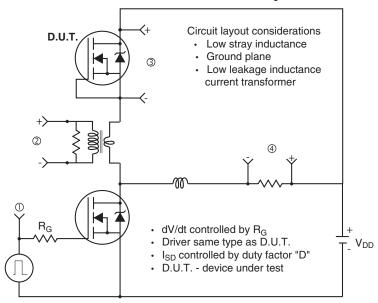


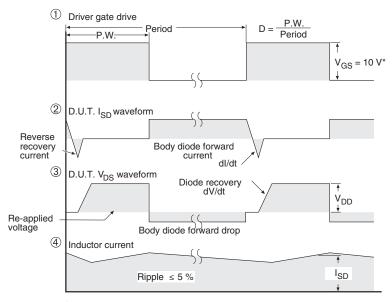
Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit





* $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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